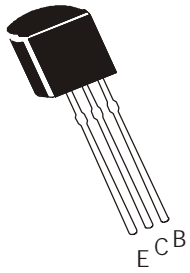


PNP SILICON PLANAR EPITAXIAL TRANSISTORS

CSB621, CSB621A



**TO-92
Plastic Package**

AF Output Amplifier

ABSOLUTE MAXIMUM RATINGS (T_a=25°C)

DESCRIPTION	SYMBOL	CSB621	CSB621A	UNITS
Collector Emitter Voltage	V _{CEO}	25	50	V
Collector Base Voltage	V _{CBO}	30	60	V
Emitter Base Voltage	V _{EBO}	5.0		V
Collector Current Peak	I _{CP}	1.5		A
Collector Current	I _C	1.0		A
Power Dissipation @ T _a =25°C	*P _C	750		mW
Junction Temperature	T _j	150		°C
Storage Temperature Range	T _{stg}	- 55 to +150		°C

*P_C=600mW/Potting type: P_C=600mW

ELECTRICAL CHARACTERISTICS (T_a=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Collector Cut off Current	I _{CBO}	V _{CB} =20V, I _E = 0			0.1	μA
Collector Base Voltage	V _{CBO}	I _C =10μA, I _E =0	CSB621	30		V
			CSB621A	60		V
Collector Emitter Voltage	V _{CEO}	I _C =2mA, I _B =0	CSB621	25		V
			CSB621A	50		V
Emitter Base Voltage	V _{EBO}	I _E =10μA, I _C =0	5			V
DC Current Gain	*h _{FE}	V _{CE} =10V, I _C =500mA	85		340	
	h _{FE}	V _{CE} =5V, I _C =1A	50			
Collector Emitter Saturation Voltage	V _{CE(sat)}	I _C =500mA, I _B =50mA			0.4	V
Base Emitter Saturation Voltage	V _{BE(sat)}	I _C =500mA, I _B =50mA			1.2	V
Transition Frequency	f _T	I _C =50mA, V _{CE} =10V		200		MHz
Output Capacitance	C _{ob}	I _E =0, V _{CB} =10V, f=1MHz			30	pF

*h_{FE} Classifications

Q : 85 - 170

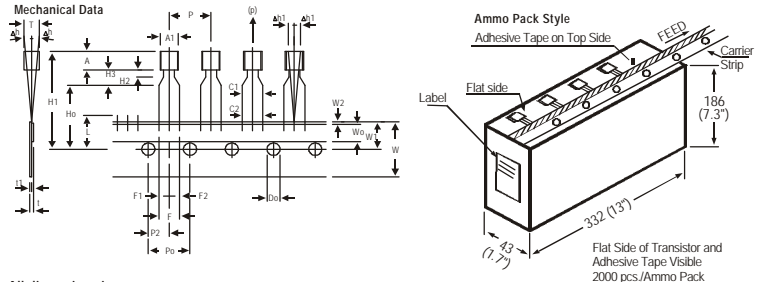
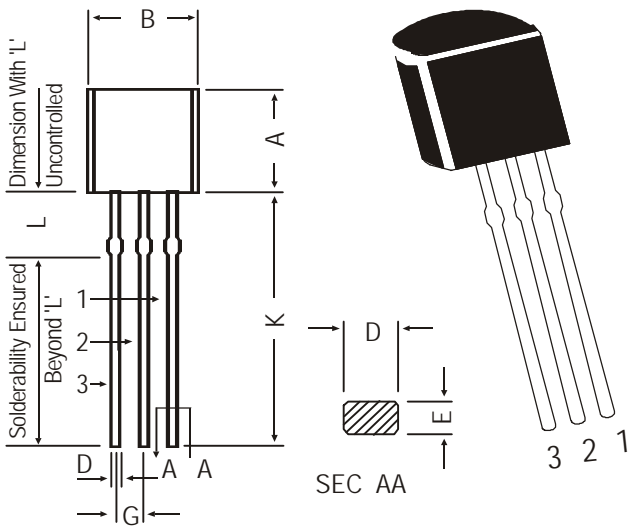
R : 120 - 240

S : 170 - 340

TO-92
Plastic Package

TO-92 Plastic Package

TO-92 Transistors on Tape and Ammo Pack

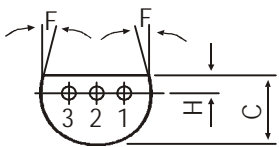


All dimensions in mm

ITEM	SYMBOL	SPECIFICATION				REMARKS
		MIN.	NOM.	MAX.	TOL.	
BODY WIDTH	A1	4.0		4.8		
BODY HEIGHT	A	4.8		5.2		
BODY THICKNESS	T	3.9		4.2		
PITCH OF COMPONENT	P	12.7			± 1.0	
FEED HOLE PITCH	Po	12.7			± 0.3	CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH
FEED HOLE CENTRE TO COMPONENT CENTRE	P2	6.35			± 0.4	TO BE MEASURED AT BOTTOM OF CLINCH
DISTANCE BETWEEN OUTER LEADS	F	5.08			+ 0.6 - 0.2	
COMPONENT ALIGNMENT SIDE VIEW	Δh	0	1.0			AT TOP OF BODY
COMPONENT ALIGNMENT FRONT VIEW	Δh1	0	1.3			AT TOP OF BODY
TAPE WIDTH	W	18			± 0.5	
HOLD-DOWN TAPE WIDTH	Wo	6			± 0.2	
HOLE POSITION	W1	9			+ 0.7 - 0.5	
HOLD-DOWN TAPE POSITION	W2	0.5			± 0.2	
LEAD WIRE CLINCH HEIGHT	Ho	16			± 0.5	
COMPONENT HEIGHT	H1		23.25			
LENGTH OF SNIPPED LEADS	L		11.0			
FEED HOLE DIAMETER	Do	4			± 0.2	
TOTAL TAPE THICKNESS	t		1.2			11 0.3-0.6
LEAD - TO - LEAD DISTANCE	F1, F2	2.54			+ 0.4 - 0.1	
STAND OFF	H2	0.45		1.45		
CLINCH HEIGHT	H3			3.0		
LEAD PARALLELISM	C1 - C2			0.22		
PULL - OUT FORCE	(P)	6N				

NOTES

- Maximum alignment deviation between leads will not be greater than 0.2mm.
- Maximum non-cumulative variation between tape feed holes shall not exceed 1 mm in 20 pitches.
- Holddown tape will not exceed beyond the edge(s) of carrier tape and there shall be no exposure of adhesive.
- There will be no more than three (3) consecutive missing components in a tape.
- A tape trailer, having at least three feed holes are provided after the last component in a tape.
- Splices should not interfere with the sprocket feed holes.



PIN CONFIGURATION

- BASE
- COLLECTOR
- EMITTER

DIM	MIN.	MAX.
A	4.32	5.33
B	4.45	5.20
C	3.18	4.19
D	0.41	0.55
E	0.35	0.50
F	5 DEG	
G	1.14	1.40
H	1.14	1.53
K	12.70	—
L	1.982	2.082

All dimensions in mm.

Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

Disclaimer

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